

XDPL8220 U100 W board description

XDP™ Digital Power

About this document

Scope and purpose

This document contains the specifications, schematics, Bill of Materials (BOM) and measurement results of the 100 W LED driver for LED lighting using the Infineon XDPL8220 dual-stage multi-mode Flyback+PFC combo controller. It also includes a fine-tuning guide and frequently asked questions to ease the process of designing a customized LED driver based on specific project requirements.

Intended audience

This document is intended for anyone wishing to design high-performance dual-stage digital Flyback AC-DC converters for LED lighting based on the PFC+Flyback combo controller XDPL8220.

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1 Introduction

The XDPL8220 100 W reference design is a digitally configurable LED driver which has universal input of 90 to 305 V AC, wide output load range of 16 to 48 V DC and isolated dimming interface (with CDM10V). Please see the next page for the main design features of this board based on XDPL8220 and CDM10V.

Note: The 100 W reference design is ready for evaluation without the need for any pre-programming by the user, as the XDPL8220 chip on the PCB has already been burned with the default full set of working parameters. Please connect the AC input, LED output and dimming input as shown in [Figure 1](#), for the test set-up.

Attention: If a low DC source with voltage output 0 ~ 10 V is used for the dimming function evaluation at the dimming interface, please switch on DC output first before the XDPL8220 100 W reference board operates (LED engine does not light), or the dimming IC CDM10V (IC201) could be damaged. (The input of the CDM10V should not be higher than the V_{CC} supply voltage.)

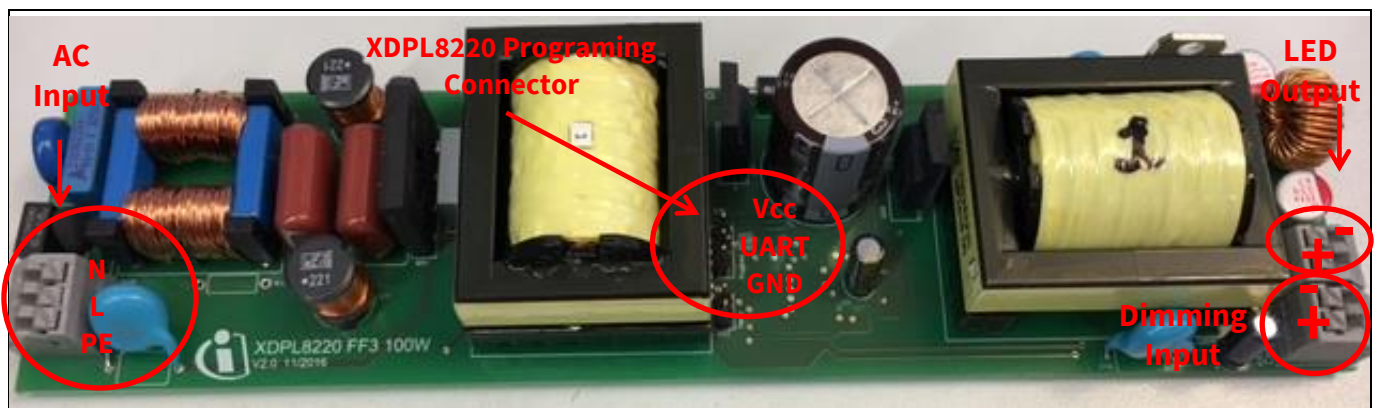


Figure 1 XDPL8220 100 W reference design with isolated dimming interface and configuration connector

2 Design features

- Dual-stage Flyback with Power Factor Correction (PFC) and high-precision primary-side controlled Constant Voltage (CV), Constant Current (CC) and Limited Power (LP) output
- Excellent current accuracy of typically +/-2 percent across universal input voltage range (90 to 305 V AC) and wide output voltage range (from 16 to 48 V)
- Integrated 600 V HV cell and PFC aux winding charge pump power supply for fast start-up time, under 250 ms
- Multi-mode control (QR+DCM) Flyback stage enables high efficiency and low dimming output
- High Power Factor (PF more than 0.9) and low input current Total Harmonic Distortion (iTHD less than 15 percent) across universal input voltage range (90 to 305 V AC) and down to 30 percent load
- Short time-to-light, down to 250 ms
- Low BOM
- Configurable dimming curve to either linear or quadratic (eye-adaptive)
- Configurable minimum dimming current from 10 percent to 5 percent
- Intelligent thermal management with adaptive temperature protection
- Active bleeder for dim-to-off function
- Output-independent forward mode auxiliary power supply for controller
- Isolated dimming interface with CDM10V

Note: CDM10V is a fully integrated 0 to 10 V dimming interface IC from Infineon which transmits secondary-side analog voltage-based signals from 0 to 10 V dimmer to the primary side, by driving an external optocoupler with a 5 mA current-based PWM signal. For more details about CDM10V, please visit the Infineon website: <http://www.infineon.com/cdm10v>

3 Design specifications

Table 1 and **Table 2** list the electrical specifications and system protections of this reference design.

Table 1 Electrical specifications

| Specification | Symbol | Value | Unit |
|--|---------------------|---------------------------|------|
| AC input voltage range | V_{in_AC} | 100 ~ 277 (+/-10 percent) | Vrms |
| DC input voltage range | V_{in_DC} | 100 ~ 277 (+/-10 percent) | V |
| Output LED load range (includes dimming) ¹ | V_{LED} | 16 ~ 48 | V |
| Non-dimmed full output current setting ² | I_{out_set} | 2500 | mA |
| Total line and load regulation tolerance | – | ±2 | % |
| Dimming input voltage range | V_{dim} | 0 ~ 10 | V |
| PWM dimming frequency | f_{dim} | 500 ~ 1500 | Hz |
| Minimum output current setting ² | $I_{out_dim_min}$ | 125 | mA |
| Output current dimming curve ² | C_{dim} | Linear/quadratic | – |
| Efficiency (V_{out} : 48 V, I_{out} : 1 A, non-dimming) | η | Less than 89 | % |
| PF (V_{in} : 90 ~ 277 V AC +/-10 percent, V_{out} : 29 ~ 48 V, more than 30 percent load) | PF | More than 0.9 | – |
| iTHD (V_{in} : 90 ~ 277 V AC +/-10 percent, V_{out} : 29 ~ 48 V, more than 30 percent load) | iTHD | Less than 15 | % |

¹ Configurable in XPDL8220.

² Configurable in XPDL8220.

Table 2 System protections

| Protection | Symbol | Value | Unit |
|--|---------------------------|--------------|------|
| Nominal input Over-Voltage Protection (OVP) level ¹ | V_{in_OV} | 320 | Vrms |
| Nominal input Under-Voltage Protection (UVP) level ² | V_{in_UV} | 72 | Vrms |
| Nominal output OVP level ² | V_{out_OV} | 53 | V |
| Nominal output over-current (average) protection level | $I_{out_max_avg}$ | 2700 | mA |
| IC internal over-temperature detection threshold ² | $T_{critical}$ | 119 | °C |
| Input OVP reaction | Reaction_OVP_Vin | Latch mode | – |
| Input UVP reaction | Reaction_UVP_Vin | Auto-restart | – |
| Output over-voltage (output open) protection reaction ³ | Reaction_OVP_Vout | Auto-restart | – |
| Output under-voltage (output short) protection reaction | Reaction_UVP_Vout | Auto-restart | – |
| Output over-current (average) protection reaction | Reaction_Iout_max_avg | Auto-restart | – |
| IC over-temperature protection reaction | Reaction_TP | Latch mode | – |
| Auto-restart idle time ⁴ | $t_{auto_restart}$ | 1 | s |
| Fast auto-restart idle time ⁵ | $t_{fast_auto_restart}$ | 150 | ms |

¹ Protection can be disabled and its level can be configured.

² Protection cannot be disabled but its level can be configured.

³ Protection reaction can be configured to either auto-restart or latch mode.

⁴ Auto-restart time can be configured.

⁵ Auto-restart time can be configured.

4 Schematic and description

Figure 2 shows the complete schematic of the 100 W reference design.

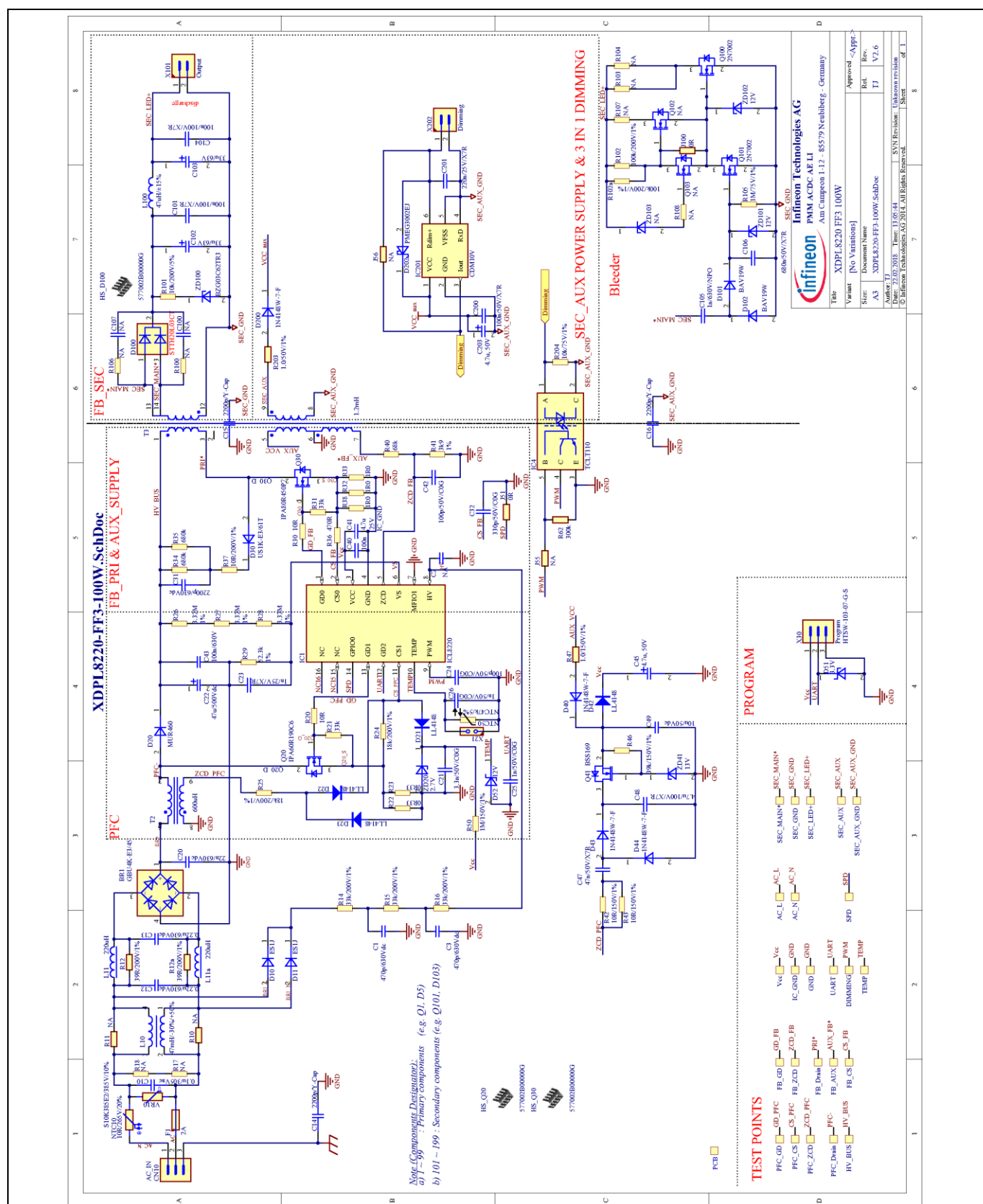


Figure 2 Schematic of the 100 W reference design

Schematic and description

The 100 W reference design is made of four main parts: input filter stage, PFC stage, Flyback stage and dimming stage.

4.1 Input stage

Input stage provides the protection not only for the application circuit, but also for the AC net from switching noises. At the same time, it rectifies the AC input to DC for the PFC stage and provides the power for the IC controller before it can be supplied by the application circuit itself.

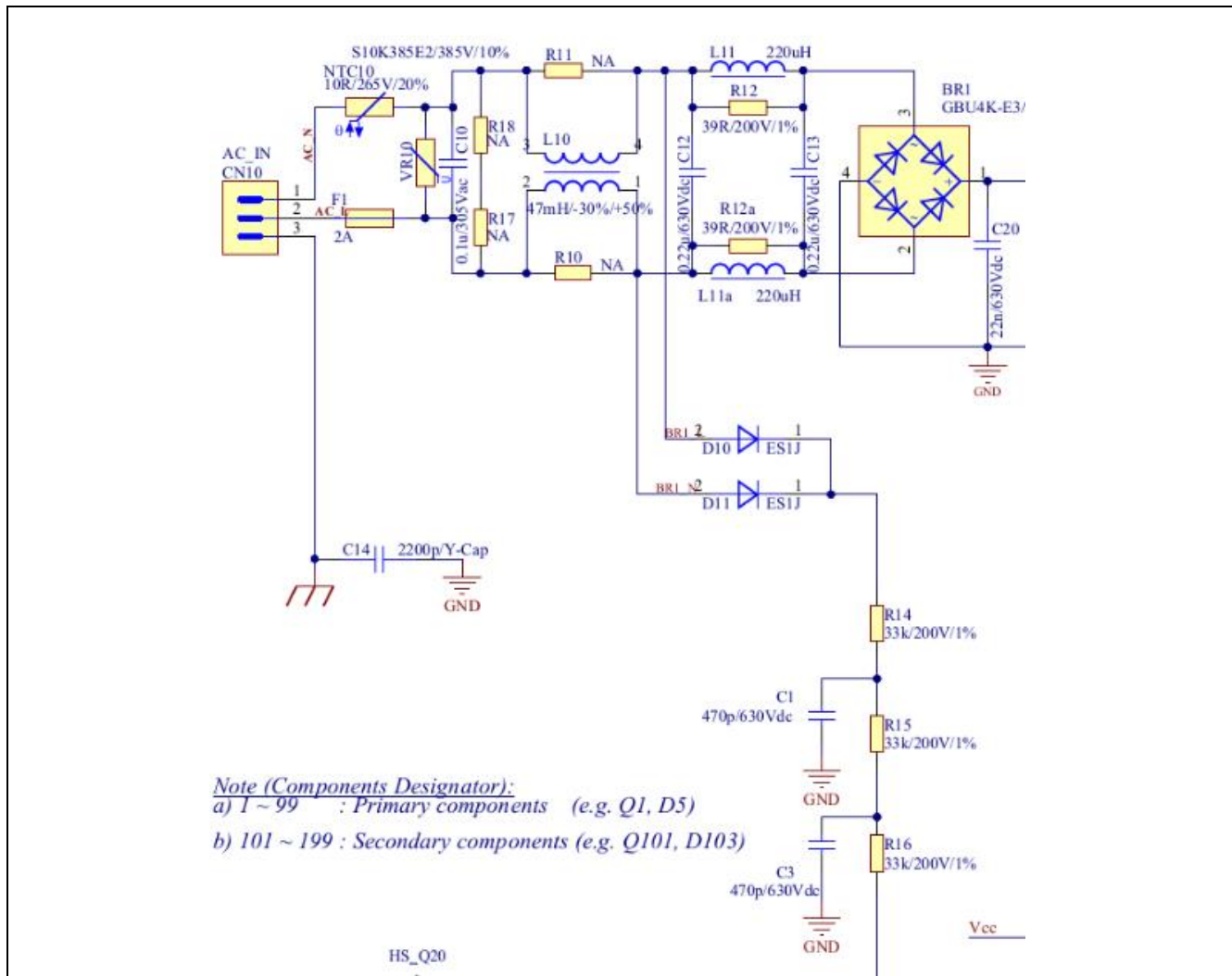


Figure 3 Input stage

It includes the following parts:

- 1) Negative Temperature Coefficient (NTC) to limit the inrush current, which charges the bus capacitors at AC plug-in
- 2) Varistor VR10 to protect the primary circuit from AC input over-voltage
- 3) X-cap discharge resistor R17, R18
- 4) Common-mode choke to suppress the common-mode noise to the mains
- 5) Differential filter to suppress the differential-mode noise to the mains
- 6) Full-bridge rectifier

Schematic and description

- 7) Full-wave AC rectification D10, D11 and current limitation R14, R15, R16 for the IC HV start-up cell via the HV pin to charge the V_{CC} capacitor at cold start-up before PFC and Flyback are running

4.2 PFC stage

The PFC stage boosts the rectified AC voltage to a higher DC voltage with much smaller ripple. Meanwhile, it shapes the input current to comply with the regulatory requirements and reduces the harmonic distortion back to the AC mains.

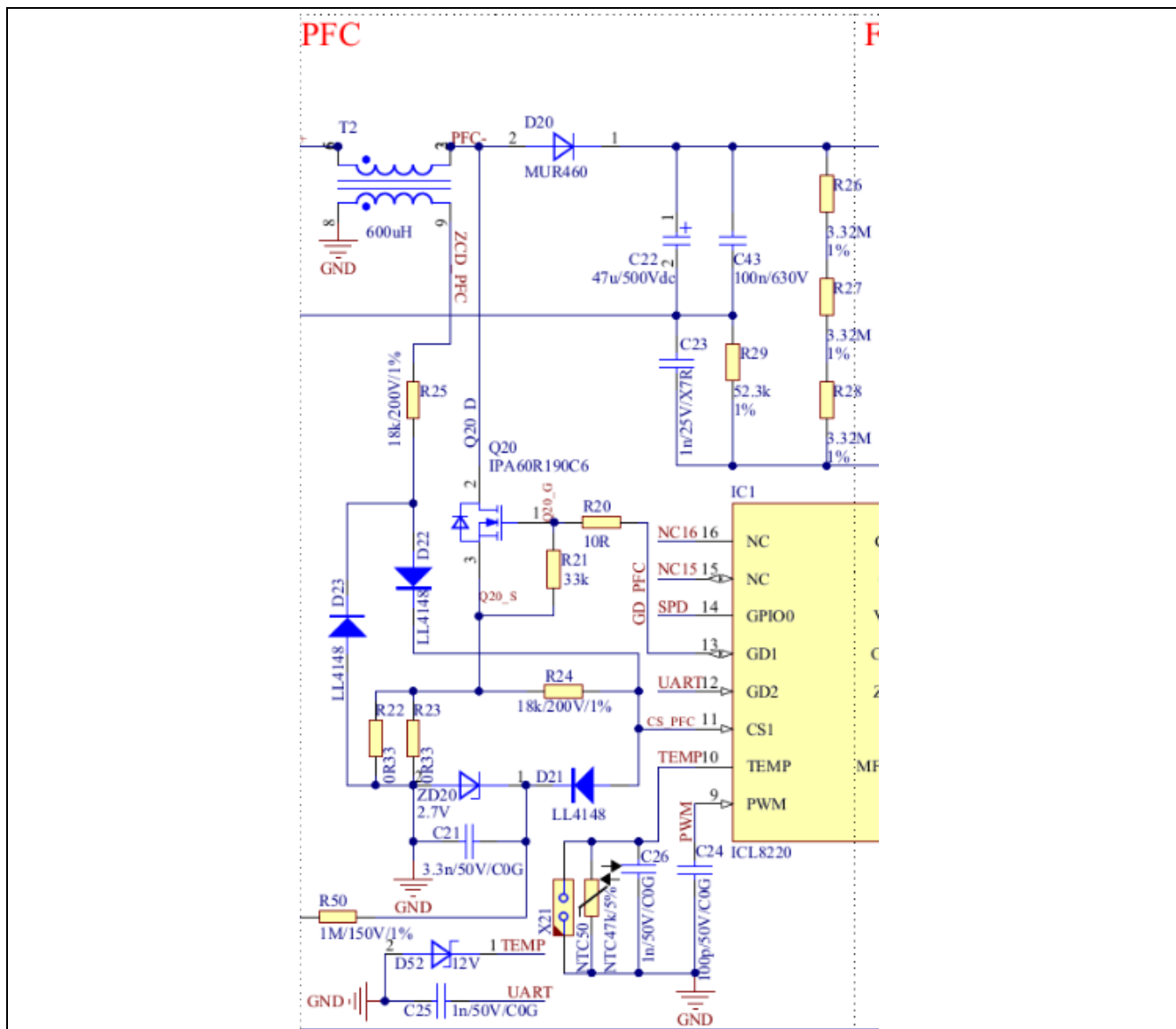


Figure 4 PFC stage

This includes the following parts:

- 1) Main PFC components with PFC choke T2, PFC power block diode D20 and PFC MOSFET Q20
- 2) Clamping circuit network for integration of Zero Crossing Detection (ZCD) and Current Sense (CS) for PFC at the same CS pin
- 3) High-frequency bypass capacitor C43, C46 and DC bus capacitor C22, C22a
- 4) Bus voltage sensing divider R26, R27, R28, R29 for DC bus voltage regulation

Schematic and description

- 5) Aux winding of the PFC choke for ZCD function and provides the power for the IC at the same time before the Flyback stage is active. Together with charge pump, it reduces the V_{CC} capacitor value so that the charging time for the V_{CC} capacitor through the start-up cell is very short, which enables a very fast time-to-light, around 250 ms at low-line.

4.3 Flyback stage

The Flyback stage converts the boosted DC bus voltage down to a lower DC voltage in a range of 16 to 48 V DC for the LED light engine. It can be split into four parts: primary side, primary aux side, secondary side and secondary aux side:

- 1) Both output voltage and current are sensed at the primary aux winding and then regulated by the controller XDPL8220.
- 2) The secondary side provides power for the LED engine with filter and protection functions.
- 3) The secondary aux winding provides power for the CDM10V, which enables the dimming function.
- 4) The primary aux winding provides the power for the controller XDPL8220 after the Flyback stage is active.

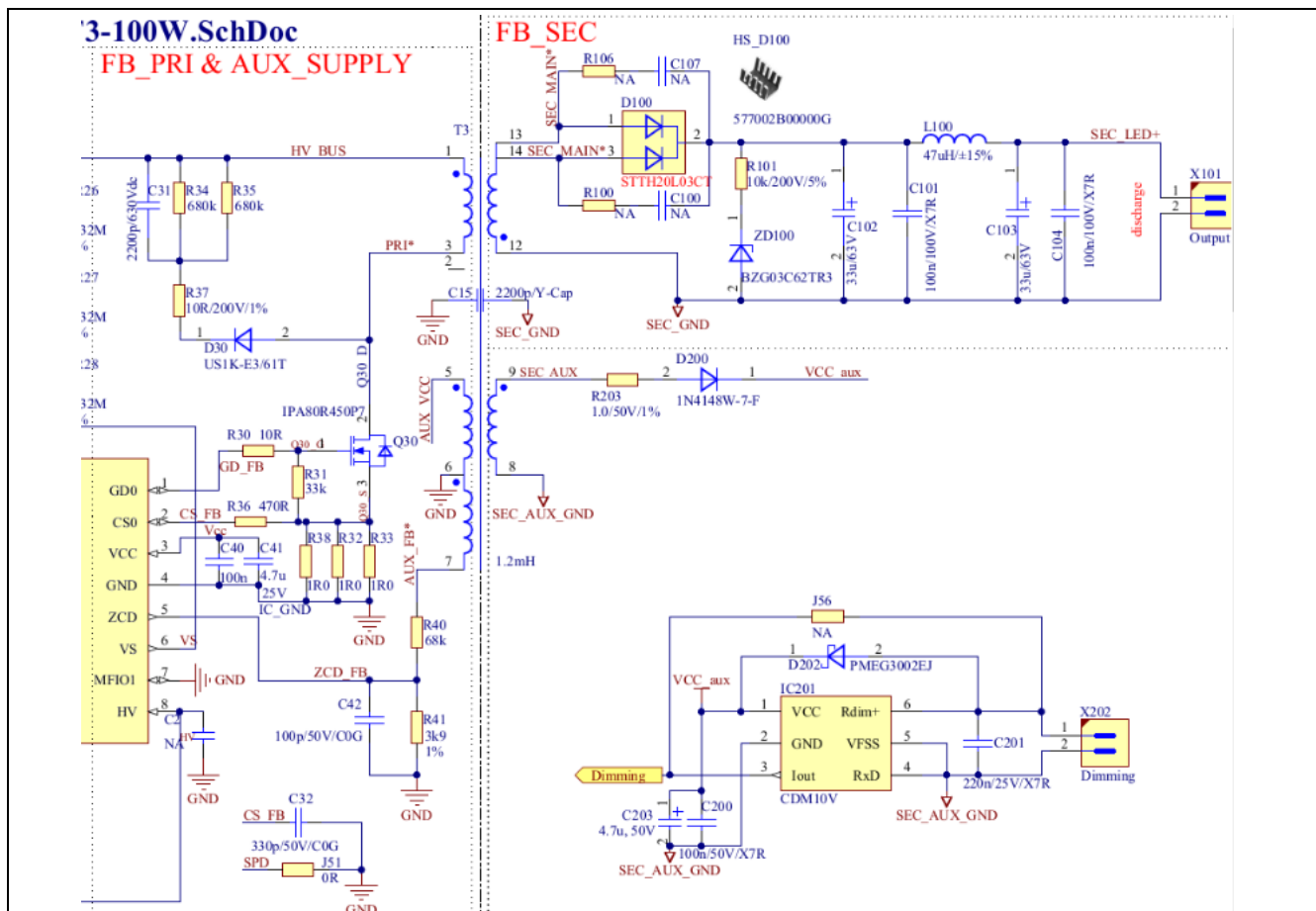


Figure 5 Flyback stage

4.3.1 Flyback primary side

The Flyback primary side includes the following parts:

- 1) The regulated power to the secondary side is controlled through the transformer T3 by switching of the power MOSFET Q30.

Schematic and description

- 2) The snubber network suppresses the oscillation in the Flyback main power path while the MOSFET Q30 turns off.
- 3) Current shunt resistors R32 and R33.

4.3.2 Flyback primary aux side

The Flyback primary aux side includes the following parts:

- 1) ZCD divider R40 and R41 for the ZCD function, which enables valley switching.
- 2) The forward mode power supply for the controller XDPL8220. This makes the V_{CC} power supply independent from the wide output voltage range and a regulator is not required.

4.3.3 Flyback secondary side

The Flyback primary aux side includes the following parts:

- 1) Rectifier D100 with snubber network R100 and C100.
- 2) R101 and ZD100 protect the output from over-voltage.
- 3) PI filter network suppresses the output noise.

4.3.4 Flyback secondary aux side

The dimming controller CDM10V is supplied by forward mode at the secondary aux winding. This makes the power supply independent from the wide output voltage range and a regulator is not necessary.

4.4 IC power supply

The IC power supply comprises three parts, as shown in [Figure 6](#).

- After the AC-DC input is plugged in and before XDPL8220 is active, the IC has power supplied by the depletion cell, which is connected to the input via the HV pin. V_{CC} capacitors are charged until the voltage reaches around 20.5 V. After the XDPL8220 is active, there is no power supply until the PFC stage is active, so the V_{CC} will drop during this period. It is important to design the V_{CC} capacitors properly so that the V_{CC} voltage does not drop below the under-voltage threshold.
- When the PFC stage is active, XDPL8220 has its power supplied from the PFC aux winding through the charge pump consisting of R42, C47, D44 and D43. The advantage of the PFC aux winding supply with charge pump is that the V_{CC} capacitors don't need to be designed to be as large, so that V_{CC} should be held above under-voltage threshold until the Flyback stage is active. This helps to achieve a fast time-to-light at the low-line condition.
- After the bus voltage reaches the defined threshold at which the Flyback stage is active, the power supply for XDPL8220 is then taken over by the Flyback aux winding in forward mode.

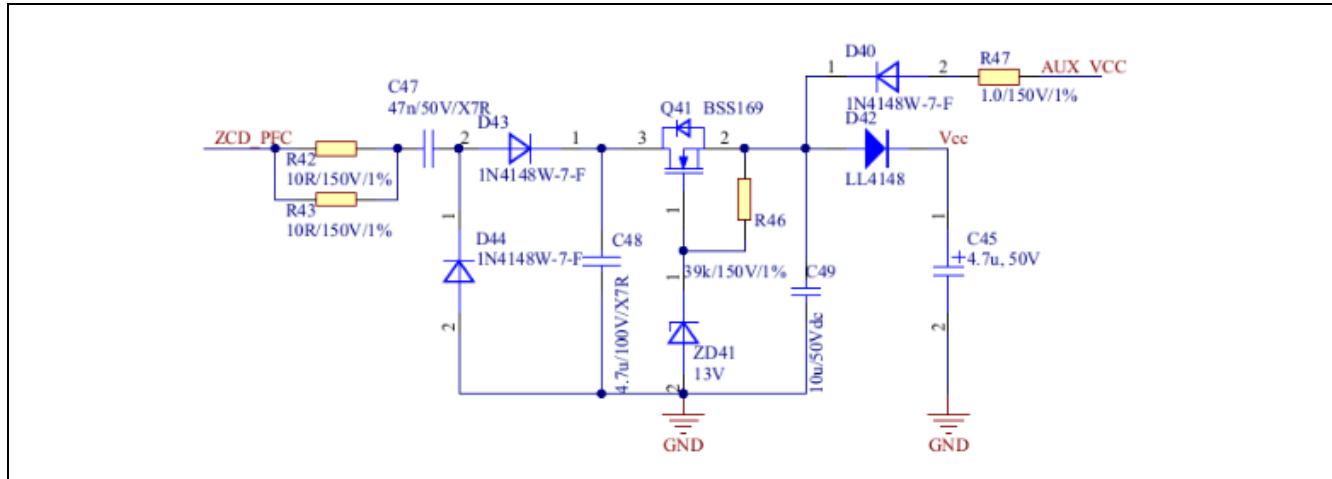


Figure 6 Forward mode V_{cc} power supply

4.5 Dimming stage

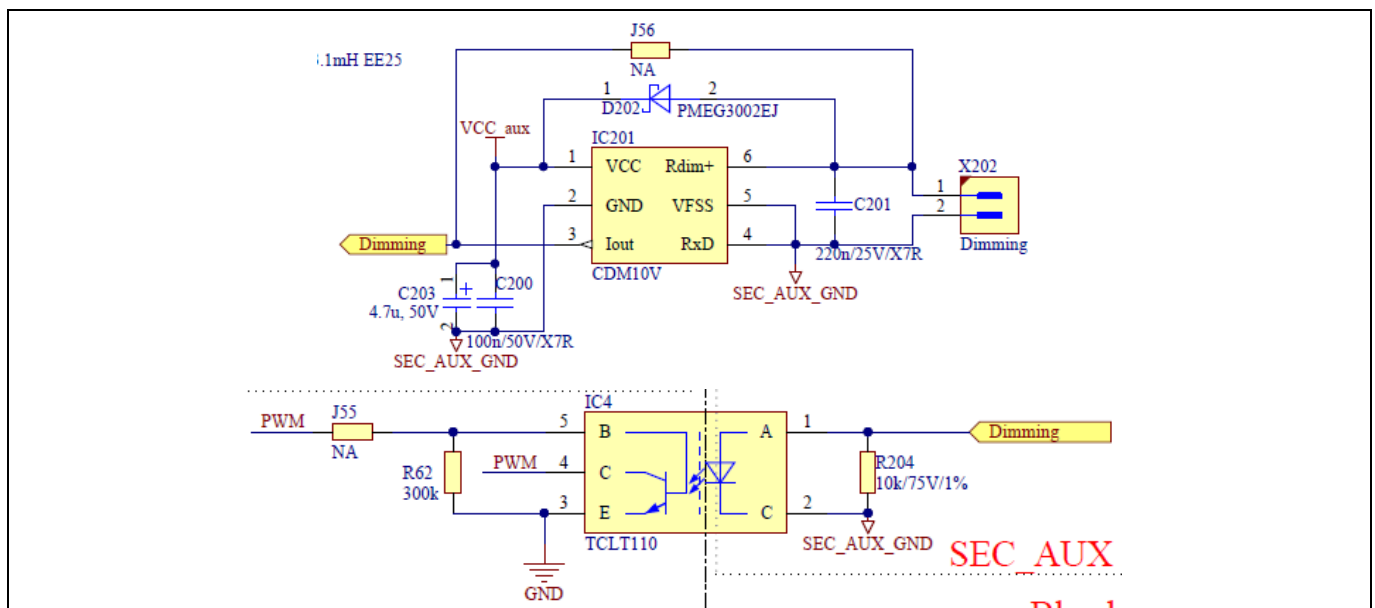


Figure 7 Dimming stage

The dimming stage is controlled by the CDM10V, as shown in **Figure 7**. This controller enables isolated dimming function:

- 1) The PWM dimming signal can be directly supplied at the connector X202, or
- 2) An analog 0 to 10 V/1 to 10 V dimmer can be connected directly at X202 and sink current is supplied by the CDM10V.
- 3) An optocoupler is needed for communication from the secondary side by CDM10V to the primary side to XDPL8220.
- 4) Resistor R204 provides bypass for the leakage current out of CDM10V.
- 5) Resistor R62 ensures fast turn-off of the optocoupler.

4.6 Bleeder

The bleeder block as shown in Figure 8 is used to discharge the LED output capacitors in the following conditions:

- 1) Fast auto-restart mode: in the dim-to-off condition, XDPL8220 enters the fast auto-restart mode and output voltage is discharged to around 12 V and stabilized there so the LED engine will not light.
- 2) Auto-restart mode: if XDPL8220 enters protection mode, any output will be periodically discharged so that the output voltage will not exceed the output over-voltage protection level.
- 3) Latch mode: if XDPL8220 enters latch mode due to certain critical failure, the output voltage will be completely discharged.
- 4) Input unplugged: if the AC-DC input power supply is unplugged, the output voltage will be completely discharged.

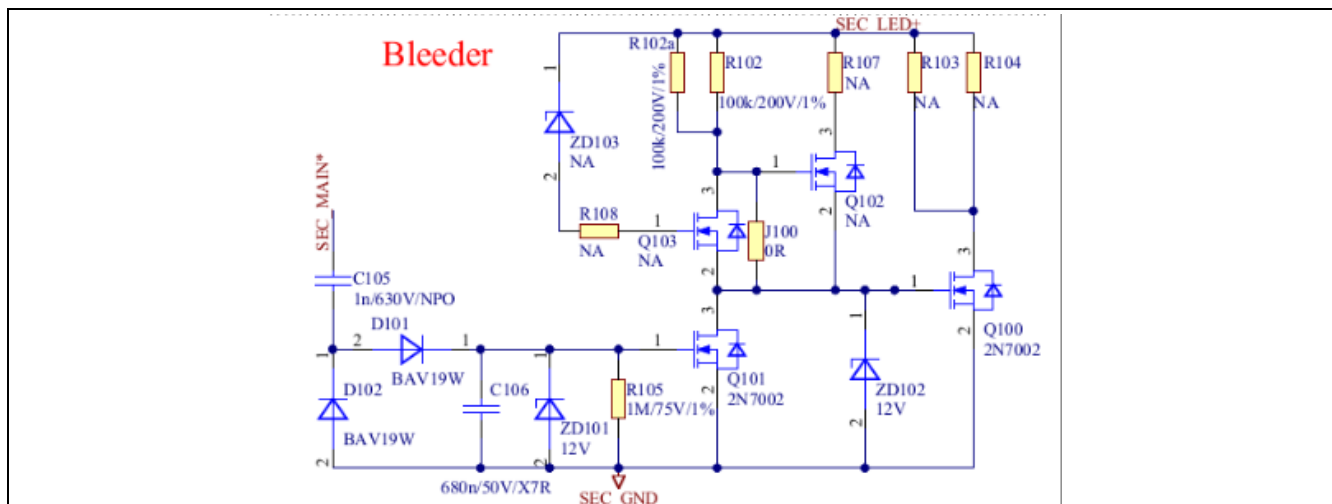


Figure 8 Active bleeder

This includes the following parts:

- 1) Charge pump C105, D102, D101 charges the C106 every switching cycle until it stabilizes at 12 V.
- 2) ZD101 clamps the voltage at C106 not higher than 12 V.
- 3) Passive bleeder resistor R102 discharges the LED output slowly.
- 4) Active bleeder resistors R103 and R104 discharge the LED output only when C106 is not charged any more and discharged by R105, and Q101 switches off.
- 5) Q101 is on as long as the Flyback stage is in normal operation so that Q100 is switched off.
- 6) At any time, if the Flyback stage stops operation, Q101 is turned off and Q100 is on, output is discharged through R103, R104 and Q100.

4.7 External adaptive temperature protection

The external adaptive temperature protection function is realized by connecting an external NTC resistor to the TEMP pin of XDPL8220. This NTC resistor is usually located near the LED engine so that it can be protected from over-temperature. The controller XDPL8220 senses the NTC resistor value change caused by the temperature variation and regulates the output current for the LED engine according to its temperature.

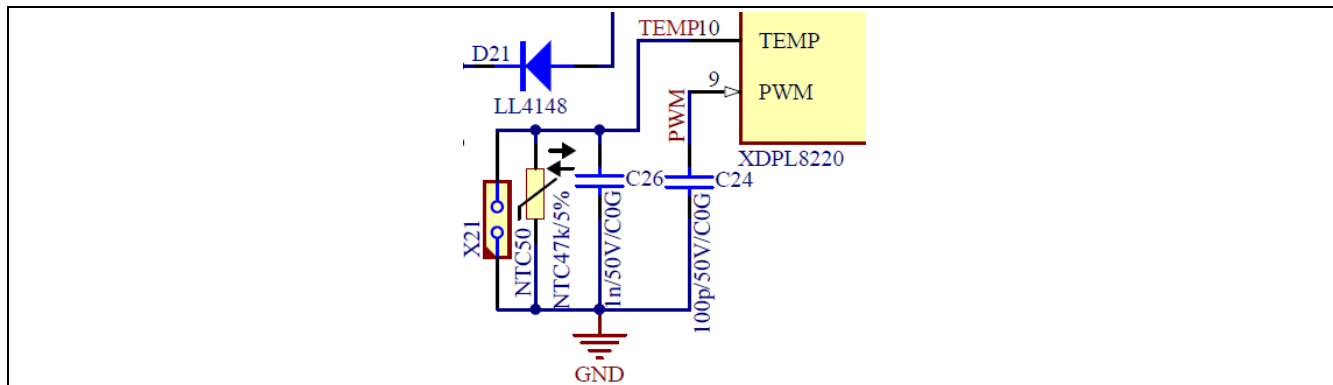


Figure 9 External NTC connection

4.8 Programming interface

The programming interface is at the connector X30. This interface is necessary for configuration of the application-related parameters through the hardware .dp Interface Gen2 and the software .dpVision.

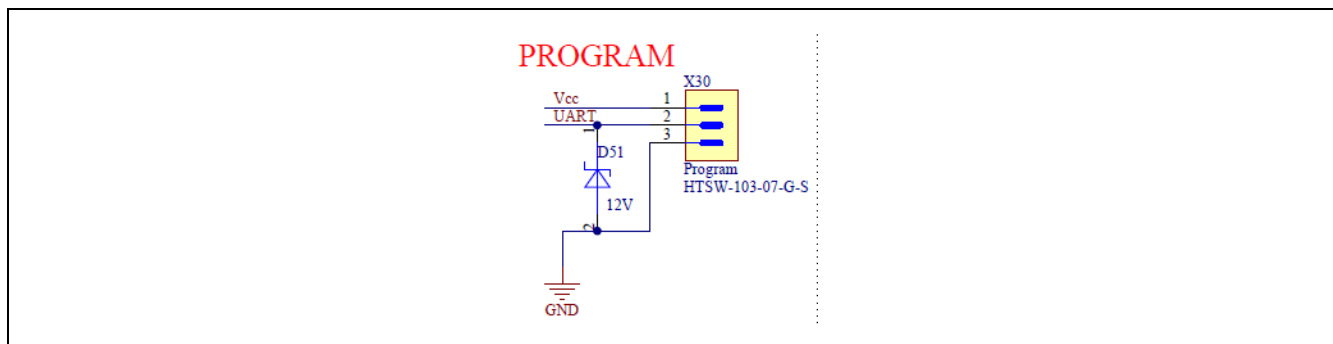


Figure 10 Programming interface

5 PCB layout

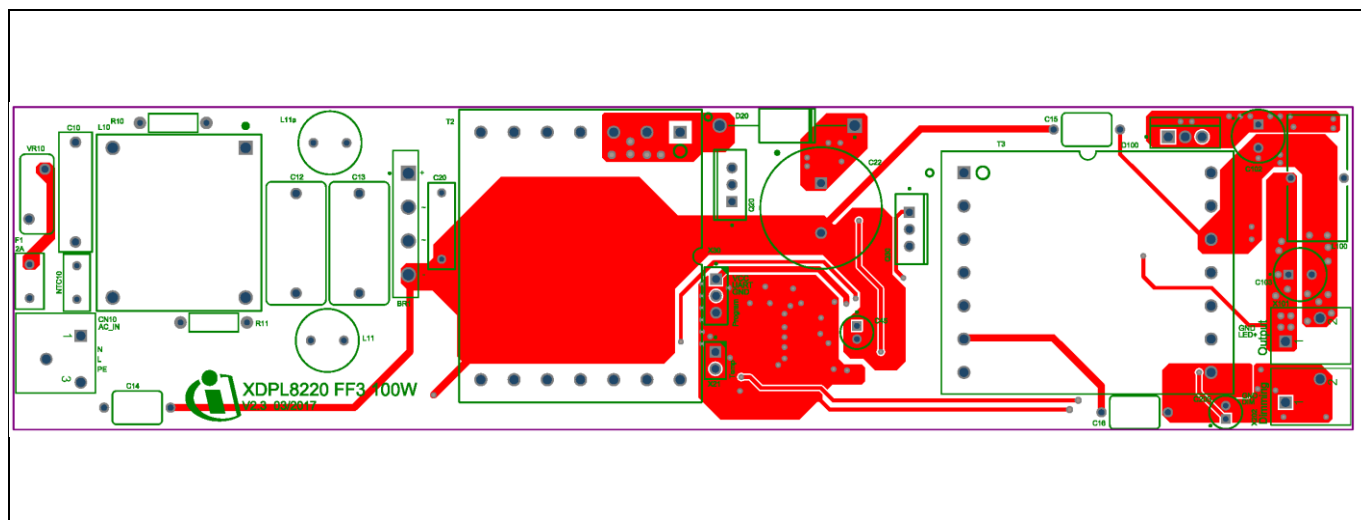


Figure 11 PCB top

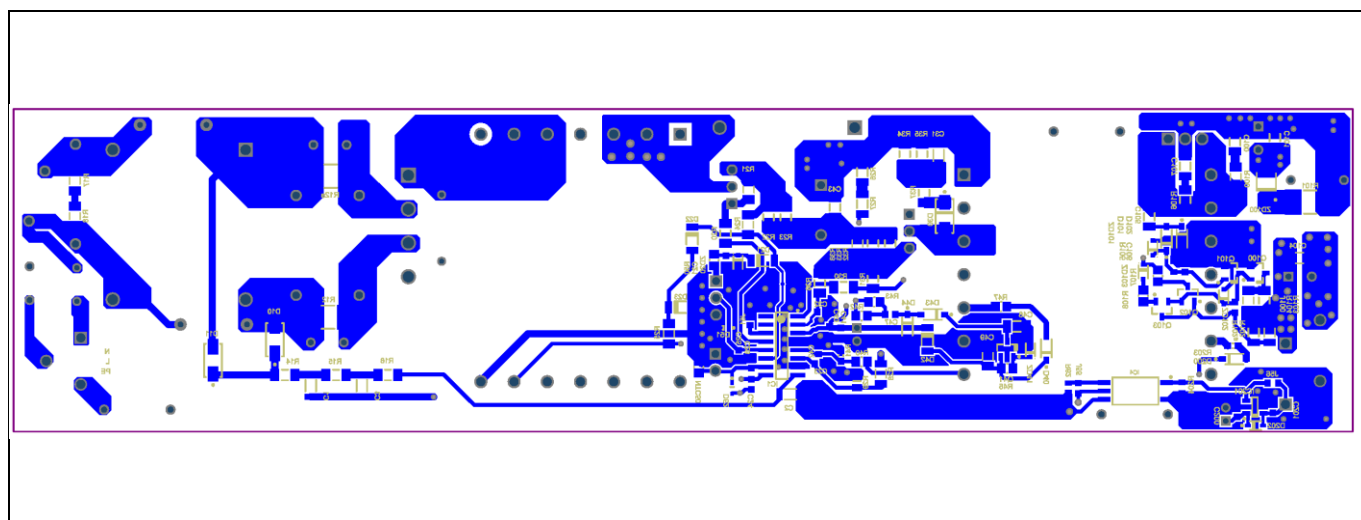


Figure 12 PCB bottom

6 Performance

Table 3 Measurement results with five LEDs

| V _{in} (V AC) | P _{in} (W) | V _{out} (V) | I _{out} (A) | Ripple (PK) (mA) | PF | THD (%) | η (%) |
|---------------------------|------------------------|-------------------------|--------------------------|---------------------|-------|------------|----------|
| 120 | 52 | 16.83 | 2.49 (100 percent) | 63.7 | 0.993 | 9.98 | 80.8 |
| 140 | 51.5 | 16.80 | 2.49 | 63.4 | 0.993 | 8.32 | 81.3 |
| 200 | 50.9 | 16.75 | 2.49 | 63.8 | 0.983 | 6.12 | 82.2 |
| 220 | 50.8 | 16.73 | 2.49 | 64.0 | 0.977 | 5.98 | 82.3 |
| 230 | 50.6 | 16.71 | 2.49 (100 percent) | 64.3 | 0.973 | 5.8 | 82.4 |
| 240 | 50.6 | 16.69 | 2.49 | 64.0 | 0.969 | 5.83 | 82.36 |
| 264 | 50.4 | 16.67 | 2.49 | 64.4 | 0.956 | 5.1 | 82.7 |
| 277 | 50.34 | 16.65 | 2.49 (100 percent) | 64.8 | 0.948 | 5.2 | 82.6 |

Table 4 Measurement results with 10 LEDs

| V _{in} (V AC) | P _{in} (W) | V _{out} (V) | I _{out} (A) | Ripple (PK) (mA) | PF | THD (%) | η (%) |
|---------------------------|------------------------|-------------------------|--------------------------|---------------------|-------|------------|----------|
| 120 | 95.9 | 32.72 | 2.49 (100 percent) | 44.2 | 0.997 | 7.3 | 82.7 |
| | 47.3 | 30.8 | 1.25 (50 percent) | 56.2 | 0.994 | 8.1 | 82.2 |
| 140 | 97.4 | 32.76 | 2.49 | 44.3 | 0.996 | 7.9 | 84.2 |
| 200 | 95.6 | 32.79 | 2.49 | 44.0 | 0.994 | 5.7 | 85.8 |
| 220 | 95.6 | 32.83 | 2.5 | 43.9 | 0.992 | 4.7 | 85.9 |
| 230 | 95.6 | 32.87 | 2.50 (100 percent) | 43.5 | 0.991 | 4.6 | 86.1 |
| | 46.3 | 30.8 | 1.26 (50 percent) | 59.3 | 0.967 | 6.2 | 84.1 |
| 240 | 95.5 | 32.95 | 2.50 | 43.8 | 0.990 | 4.5 | 86.2 |
| 264 | 95.6 | 33.01 | 2.50 | 43.6 | 0.986 | 4.6 | 86.5 |
| 277 | 95.9 | 33.16 | 2.50 | 43.3 | 0.983 | 4.7 | 86.6 |

Performance

| V _{in} (V AC) | P _{in} (W) | V _{out} (V) | I _{out} (A) | Ripple (PK) (mA) | PF | THD (%) | η (%) |
|---------------------------|------------------------|-------------------------|-------------------------|---------------------|-------|------------|----------|
| | | | (100 percent) | | | | |
| | 46.3 | 30.7 | 1.27 (50 percent) | 58.4 | 0.937 | 5.6 | 84.3 |

Table 5 Measurement results with 14 LEDs

| V _{in} (V AC) | P _{in} (W) | V _{out} (V) | I _{out} (A) | Ripple (PK) (mA) | PF | THD (%) | η (%) |
|---------------------------|------------------------|-------------------------|-------------------------|---------------------|-------|------------|--------------|
| 120 | 120.2 | 45.31 | 2.20 (100 percent) | 42.8 | 0.997 | 6.8 | 83.9 |
| | 56.3 | 42.15 | 1.10 (50 percent) | 55.9 | 0.993 | 9.8 | 82.9 |
| | 28.3 | 40.02 | 0.56 (25 percent) | 26.3 | 0.987 | 11.1 | 80.2 |
| 140 | 117.8 | 45.15 | 2.20 | 42.7 | 0.996 | 7.4 | 84.8 |
| 200 | 114.9 | 45.02 | 2.21 | 42.9 | 0.995 | 5.5 | 86.7 |
| 220 | 114.5 | 44.87 | 2.22 | 43.1 | 0.994 | 5.3 | 87.1 |
| 230 | 114.3 | 44.82 | 2.22 (100 percent) | 43.2 | 0.993 | 5.2 | 87.3 |
| | 54.9 | 42.23 | 1.10 (50 percent) | 56.1 | 0.977 | 5.8 | 85.1 |
| | 27.9 | 40.07 | 0.56 (25 percent) | 26.7 | 0.924 | 6.6 | 81.0 percent |
| 240 | 114.2 | 44.73 | 2.22 | 43.1 | 0.992 | 5.2 | 87.3 |
| 265 | 114.0 | 44.69 | 2.23 | 43.1 | 0.989 | 4.4 | 87.5 |
| 277 | 113.7 | 44.63 | 2.23 (100 percent) | 43.0 | 0.984 | 4.6 | 87.6 |
| | 54.3 | 42.26 | 1.12 (50 percent) | 43.8 | 0.956 | 5.2 | 85.6 |
| | 27.0 | 39.21 | 0.57 (25 percent) | 27.2 | 0.867 | 7.5 | 81.2 |

Performance

Note: Due to the LP mode, the current is limited so that the output power does not exceed the defined 100 W.

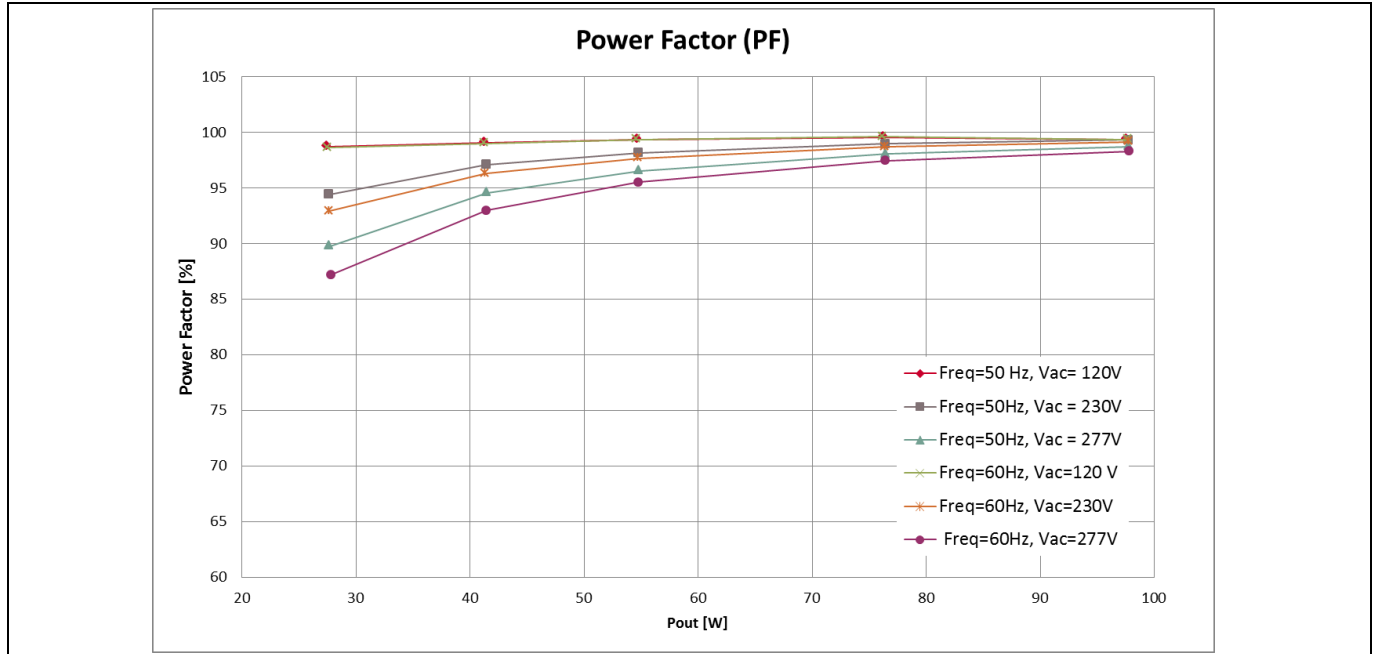


Figure 13 XDPL8221 100 W reference board PF with 13 LEDs

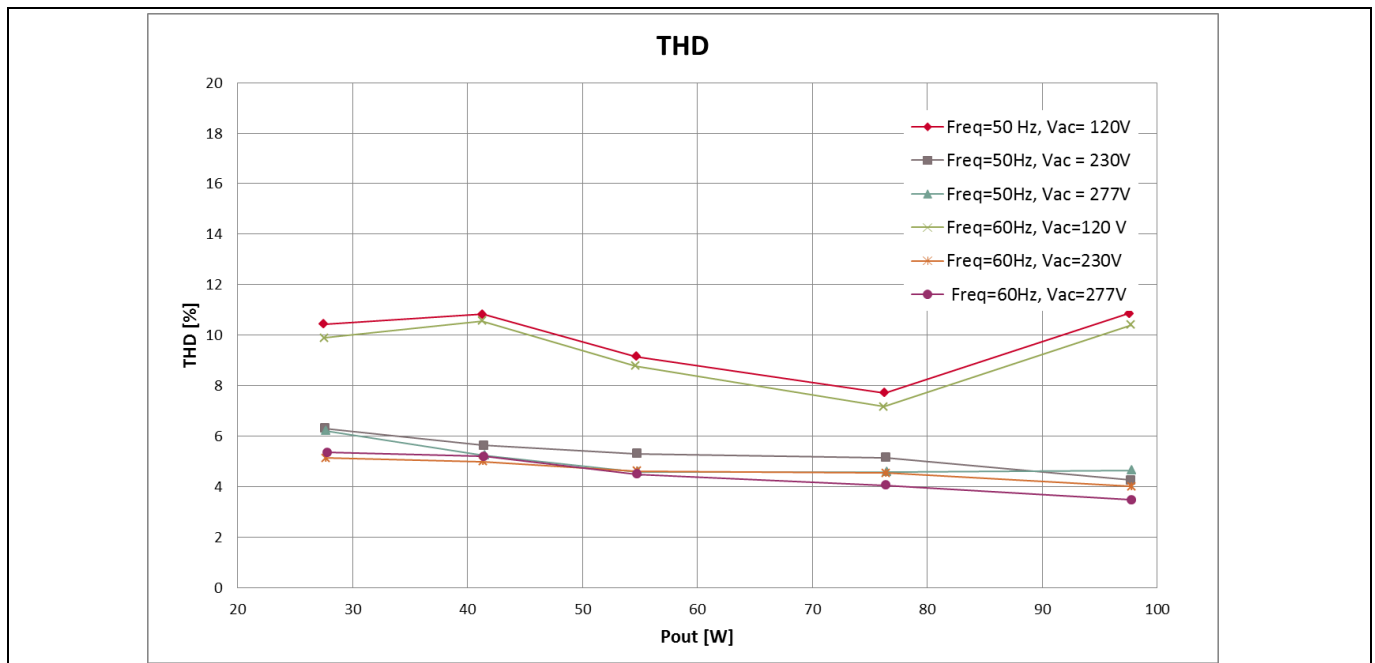


Figure 14 XDPL8221 100 W reference board THD with 13 LEDs

Note: Due to the limited power mode, the current is limited so that the output power does not exceed the defined 100 W.

Performance

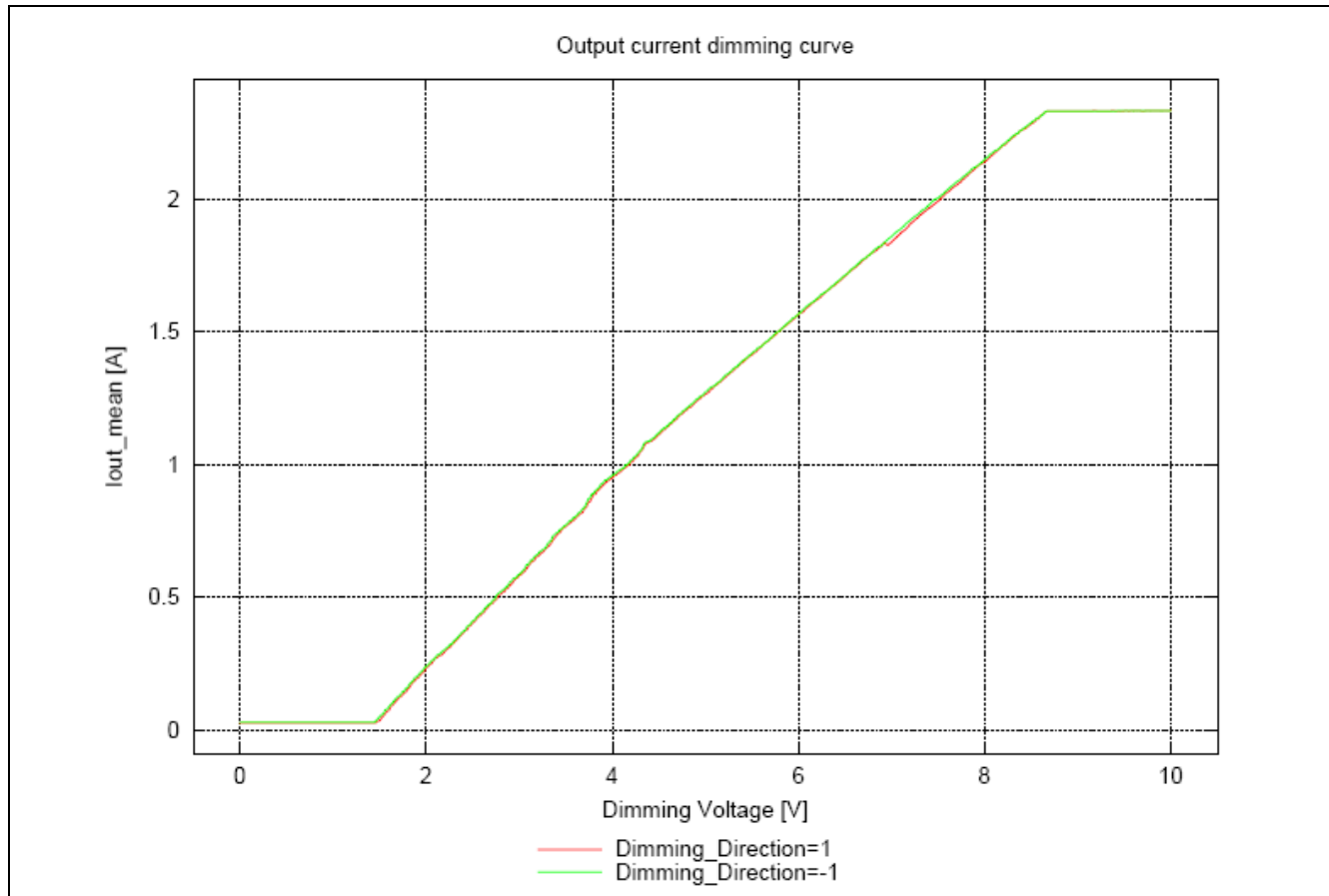
6.1 0 to 10 V dimming

This section provides measurement results for the 0 to 10 V dimming feature. A linear curve was configured for this measurement using the .dpVision GUI. The measurement was done for an input voltage of 230 V AC, 50 Hz and an output load of 14 LEDs.

Table 6 Output current at different dimming voltages with 14 LEDs

| V _{dim} (V) | 0.50 | 1.00 | 1.50 | 2.00 | 2.50 | 3.00 | 3.50 | 4.00 | 4.50 | 5.00 |
|----------------------|-------|-------|-------|------|------|------|------|------|------|-------|
| I _{out} (A) | 0.125 | 0.125 | 0.125 | 0.25 | 0.39 | 0.59 | 0.75 | 0.91 | 1.08 | 1.23 |
| V _{dim} (V) | 5.50 | 6.00 | 6.50 | 7.00 | 7.50 | 8.00 | 8.50 | 9.00 | 9.50 | 10.00 |
| I _{out} (A) | 1.37 | 1.53 | 1.67 | 1.80 | 1.93 | 2.07 | 2.19 | 2.21 | 2.21 | 2.21 |

Note: Due to the LP mode, the current is limited so that the output power does not exceed the defined 100 W.

**Figure 15 XDPL8220 100 W reference board linear dimming curve with V AC = 230 V/50 Hz, 13 LEDs**

6.2 0 to 10 V eye-adapted dimming

This section provides measurement results for the 0 to 10 V dimming feature with an eye-adapted (quadratic) curve. The measurement was done for an input voltage of 230 V AC, 50 Hz and an output load of 14 LEDs (48 V at maximum limited current).

Table 7 Output current at different dimming voltages

| | | | | | | | | | | |
|----------------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|--------------|
| V _{dim} (V) | 0.50 | 1.00 | 1.50 | 2.00 | 2.50 | 3.00 | 3.50 | 4.00 | 4.50 | 5.00 |
| I _{out} (A) | 0.125 | 0.125 | 0.125 | 0.125 | 0.125 | 0.143 | 0.254 | 0.354 | 0.490 | 0.654 |
| | | | | | | | | | | |
| V _{dim} (V) | 5.50 | 6.00 | 6.50 | 7.00 | 7.50 | 8.00 | 8.50 | 9.00 | 9.50 | 10.00 |
| I _{out} (A) | 0.831 | 1.02 | 1.23 | 1.42 | 1.67 | 1.90 | 2.17 | 2.21 | 2.21 | 2.21 |

Note: Due to the LP mode, the current is limited so that the output power does not exceed the defined 100 W.

BOM

7 BOM

Table 8 XDPL8221 100 W reference board BOM

| Quantity | Designator | Value | Description | Manufacturer | Part number |
|----------|---------------|--------------|--|--------------|----------------------|
| 1 | BR1 | GBU4K-E3/45 | 4 A, 800 V, SIP4 | Diodes | GBU4K-E3/45 |
| 2 | C1, C3 | 470 p | Cap-1206-470p/630 V/5 percent/C0G | TDK | C3216C0G2J471J085AA |
| 1 | C10 | 0.1 μ | EMI cap 100 n/305 V/X2/10 percent | TDK | B32922C3104K |
| 2 | C12, C13 | 0.22 μ | Metallized polyester film capacitor | Panasonic | ECQE6224JF |
| 3 | C14, C15, C16 | 2200 p/Y-cap | Y-cap 2200 pF/250 V/pitch 10 | Murata | DE1E3KX222MA5B |
| 1 | C20 | 22 n | MKT, 22 nF/630 V/ \pm 10 percent, 15 mm, 4 x 12.5 mm | Vishay | BFC237261223 |
| 1 | C21 | 3.3 n | Cap-0603-3.3 n/50 V/0.01/C0G | Kemet | C0603C332J5GACTU |
| 1 | C22 | 47 μ | Miniature aluminum electrolytic capacitor | Rubycon | 500BXC47MEFC18X31.5 |
| 1 | C23 | 1 n | Cap-0603-1 n/25 V/0.1/X7R | AVX | 06033C102K4Z2A |
| 2 | C24, C42 | 100 p | Cap-0603-100p/50 V/0.1/C0G | AVX | 06035A101FAT2A |
| 2 | C25, C26 | 1 n | Cap-0603-1n/50 V/0.01/C0G | Murata | GRM1885C1H102F |
| 1 | C31 | 2200 p | Cap-1206-2200p/630 V/10 percent/X7R | Murata | GRM31BR72J222KW01L |
| 1 | C32 | 330 p | Cap-0603-330p/50 V/0.01/C0G | Kemet | C0603C331F5GAC |
| 2 | C40, C200 | 100 n | Cap-0603-100n/50 V/0.1/X7R | AVX | 06035C104K4Z2A |
| 1 | C41 | 4.7 μ | Cap-0603-4.7u/25V/10 percent/X5R | Murata | GRM188R61E475KE11D |
| 1 | C43 | 0.10 μ | Cap-1210-100n/630 V/10 percent/X7T | TDK | CGA6L1X7T2J104K160AC |
| 2 | C45, C203 | 4.7 μ | Al cap 4.7 μ F/50 V/pitch 2 mm | Panasonic | EEUFC1H4R7 |
| 1 | C47 | 47n | Cap-0603-47n/50 V/0.1/X7R | Murata | GRM188R71H473KA61D |
| 1 | C48 | 4.7 u | Cap-1206-4.7u/100 V/0.1/X7S | AVX | 12061Z475KAT2A |
| 1 | C49 | 10 μ | Cap-1206-10u/50 V/10 percent/X5R | Murata | GRM31CR61H106KA12# |

XDPL8220 U100 W board description

XDPTM Digital Power



BOM

| Quantity | Designator | Value | Description | Manufacturer | Part number |
|----------|-------------------------|----------------|---|------------------------------|----------------------|
| 2 | C101, C104 | 100 n | Cap-1206-100n/100 V/0.1/X7R | TDK | C3216X7R2A104K160AA |
| 2 | C102, C103 | 33 μ | Al cap 33 μ F/63 V/pitch 3.5/DxH8,00 x 12.00 mm | Nichicon | RNU1J330MDN1KX |
| 1 | C105 | 1 n | Cap-1206-1n/630 V/0.5/NPO | TDK | CGA5F4C0G2J102J085AA |
| 1 | C106 | 680 n | Cap-0603-680n/50 V/0.1/X5R | TDK | C1608X5R1H684K080AB |
| 1 | C201 | 220 n | Cap-0603-220 n/25 V/0.2/X7R | Kemet | C0603C224K3RACTU |
| 1 | CN10 | 691412120003MB | 7.92 mm contact pitch, right-angle header | Würth Elektronik | 691412120003MB |
| 2 | D10, D11 | ES1J | Ultra-fast diode 600 V/1 A/DO-214AC | Fairchild Semiconductor | ES1J |
| 1 | D20 | MUR460 | Ultra-fast switch mode power rectifier 4.0 A/600 Vrrm | ON Semiconductor | MUR460G |
| 3 | D21, D22, D23 | LL4148 | Small-signal diode/100 V | Fairchild Semiconductor | LL4148 |
| 1 | D30 | US1K-E3/61T | Ultra-fast diode 800 V/1.0 A/DO-214AC | Vishay General Semiconductor | US1K-E3/61T |
| 4 | D40, D43, D44, D200 | 1N4148W-7-F | Surface-mount fast-switching diode | Diodes Incorporated | 1N4148W-7-F |
| 1 | D42 | LL4148 | Diode 100 V, 200 mA, SOD80 (Melf) | Fairchild Semiconductor | LL4148 |
| 1 | D51 | PESD3V3S1UB | Unidirectional ESD protection diode/3.3 V | NXP | PESD3V3S1UB |
| 1 | D52 | PESD12VS1UB | Unidirectional ESD protection diode/12 V | NXP | PESD12VS1UB |
| 1 | D100 | STTH20L03CT | Dual diode, TO220AB, 100 V, CC | ST | STTH20L03CT |
| 2 | D101, D102 | BAV19W | Diode 100 V, 400mA, SOD123 | Diodes Inc. | BAV19W |
| 1 | D202 | PMEG3002EJ | Schottky diode/30 V, 200 mA, SOD323 | NXP | PMEG3002EJ |
| 1 | F1 | 2 A | Radial lead fuse rectangular – slow blow, 2 A, 250 V | Multicomp | MST 2A 250 V |
| 3 | HS_D100, HS_Q20, HS_Q30 | 577002B00000G | Slim low-cost channel-style heatsink | Aavid Thermalloy | 577002B00000G |
| 1 | IC1 | ICL8220 | LED combo control IC for PFC and FB | Infineon Technologies | ICL8220B13 |

XDPL8220 U100 W board description

XDP™ Digital Power

BOM



| Quantity | Designator | Value | Description | Manufacturer | Part number |
|----------|-------------------------|-------------|--|-----------------------|------------------|
| | | | conversion | | |
| 1 | IC4 | TCLT110 | Optocoupler, phototransistor output, CTR 100 percent to 200 percent at 10 mA (operating temp. - 55°C to 100°C) | Vishay | TCLT1103 |
| 1 | IC201 | CDM10V | Dimming interface IC SOT-23-6 | Infineon Technologies | CDM10V |
| 2 | J51, J100 | 0 R | 0 R/50 V | Bourns | CR0603-J/-000ELF |
| 1 | L10 | 47 mH | Current-compensated frame-core double choke | Epcos | B82733F2112B001 |
| 2 | L11, L11a | 220 µH | IND 220 µH, 1.6 ARMS, 0R26, pitch 5 mm, 13 x 10 x 15 mm | Würth Elektronik | 7447480221 |
| 1 | L100 | 47 µH | Tor-choke 47 µH/3.6 A/15 percent | Bourns JW Miller | 2109-H-RC |
| 1 | NTC10 | 10 R | 10 R/265 V/20 percent | Epcos | B57235S0100M0 |
| 1 | NTC50 | NTC47k | NTC47k/5 percent/0805 | Epcos | B57471V2473J062 |
| 1 | PCB | PCB | PCB, 201.5 x 48.5 mm, two-layer, 35 µm, FR4, 1.55 mm standard, solder mask green both sides, silkscreen white both sides | | |
| 1 | Q20 | IPA60R190C6 | 650 V CoolMOS™ C6, 0.19 Ω, TO220FP | Infineon Technologies | IPA60R190C6 |
| 1 | Q30 | IPA80R450P7 | 800 V CoolMOS™ P7, 0.45 Ω, TO220FP | Infineon Technologies | IPA80R450P7 |
| 1 | Q41 | BSS169 | MOSFET N-Ch, 100 V, 90 mA, 12 Ω, SOT23 | Infineon Technologies | BSS169 |
| 2 | Q100, Q101 | 2N7002 | OptiMOS transistor 60 V, 3 Ω, 300 mA, SOT23 | Infineon Technologies | 2N7002 |
| 2 | R12, R12a | 39 R | 39 R/200 V/1 percent | TE Connectivity | 352039RJT |
| 5 | R14, R15, R16, R21, R31 | 33 k | 33 k/200 V/1 percent | Yageo/Phycomp | RC1206FR-0733K |
| 2 | R17, R18 | 1 M | 1 M/200 V/1 percent | Yageo/Phycomp | RC1206FR-071M0L |
| 3 | R20, R30, R37 | 10 R | 10 R/200 V/1 | Yageo/Phycomp | RC1206FR-7W10R |

XDPL8220 U100 W board description

XDPTM Digital Power

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| Quantity | Designator | Value | Description | Manufacturer | Part number |
|----------|---------------|-----------------|--|------------------|----------------------|
| | | | percent | | |
| 2 | R22, R23 | 0R33 | 0.33/675 mV/1 percent | Bourns | CRM1206-FX-R330 E LF |
| 2 | R24, R25 | 18 k | 18 k/200 V/1 percent | Yageo/Phycomp | RC1206FR-0718K |
| 3 | R26, R27, R28 | 3.32 M | 3.32 M/200 V/1 percent | Vishay | CRCW12063M32FKEA |
| 1 | R29 | 52.3 k | 52.3 k/150 V/1 percent | Panasonic | ERJP06F5232V |
| 3 | R32, R33, R38 | 1R0 | 1.0 R/200 V/1 percent | Panasonic | ERJ8BQF1R0V |
| 2 | R34, R35 | 680 k | 680 k/200 V/1 percent | Yageo/Phycomp | RC1206FR-07680K |
| 1 | R36 | 470 R | 470 R/200 V/1 percent | Yageo/Phycomp | RC1206FR-07470R |
| 1 | R40 | 68 k | 68 k/150 V/1 percent | Yageo/Phycomp | RC0805FR-0768KL |
| 1 | R41 | 3k9 | 3.9 k/50 V/1 percent | Yageo/Phycomp | RC0603FR-073K9L |
| 2 | R42, R43 | 10 R | 10 R/150 V/330 mW/1 percent | TE Connectivity | CRGH0805F10R |
| 1 | R46 | 39 k | 39 k/150 V/1 percent | Yageo/Phycomp | RC0805FR-0739KL |
| 1 | R47 | 1.0 | 1.0/150 V/1 percent | Yageo/Phycomp | RC0805FR-071RL |
| 1 | R50 | 1 M | 1 M/150 V/1 percent | Yageo/Phycomp | RC0805FR-071M |
| 1 | R62 | 300 k | 300 k/75 V/1 percent | Vishay | CRCW0603300KFKED |
| 1 | R101 | 10 k | 10 k/200 V/5 percent/2512 | Yageo | RC2512JK-0710KL |
| 2 | R102, R105 | 1 M | 1 M/75 V/1 percent | Yageo/Phycomp | RC0603FR-071ML |
| 2 | R103, R104 | NA | 2 k/200 V/1 percent | Vishay | CRCW12062K00FKEA |
| 1 | R203 | 1.0 | 1.0/50 V/1 percent | Yageo/Phycomp | RC0603FR-071RL |
| 1 | R204 | 10 k | 10 k/75 V/1 percent | Yageo/Phycomp | RC0603FR-0710KL |
| 1 | T2 | 600 µH | ERL35, 14 pin 1600 µH, 1.16 A, N87, Gab 0.4 mm | Würth Elektronik | 750343236 Rev00 |
| 1 | T3 | 1.2 mH | ERL35, 14 pin, N87, 1200 µH, 2 A | Würth Elektronik | 750343235Rev00 |
| 1 | VR10 | S10K385E2K1 | S10K385E2K1/385 V/10 percent | Epcos | B72210S0381K101 |
| 1 | X30 | HTSW-103-07-G-S | Through-hole 0.025" SQ post header, 2.54 mm pitch, three pin, vertical, single row | Samtec | HTSW-103-07-G-S |
| 2 | X101, X202 | 691412120002MB | Through-hole shrouded header, top entry, vertical, | Würth Elektronik | 691412120002MB |

XDPL8220 U100 W board description

XDPTM Digital Power

BOM



| Quantity | Designator | Value | Description | Manufacturer | Part number |
|----------|---|-------------|---|---------------------------|---------------------|
| | | | 2.5 mm pitch, two pins, single row, white | | |
| 1 | ZD20 | BZX384-C2V7 | Zener diode/2.7 V/SOD-323 | NXP | BZX384-C2V7 |
| 1 | ZD41 | BZX384-C13 | Zener diode/13 V/SOD-323 | NXP | BZX384-C13 |
| 1 | ZD100 | SS16HE3 | Schottky diode/60 V/1 A/DO-214AC | Vishay | SS16-E3/5AT |
| 2 | ZD101, ZD102 | BZX384-C12 | Zener diode/12 V/SOD-323 | NXP | BZX384-C12 |
| 0 | AC_L, AC_N, DIMMING, FB_AUX, FB_CS, FB_Drain, FB_ZCD, GND, HV_BUS, IC_GND, PFC_CS, PFC_Drain, PFC_GD, PFC_ZCD, SEC_AUX, SEC_AUX_GND, SEC_GND, SEC_LED+, SEC_MAIN*, SPD, TEMP, UART, V _{CC} | TP SMD | Test pad not assembled | | |
| 0 | C2 | NA | Cap-1206-470p/630 V/5 percent/C0G | TDK | C3216C0G2J471J085AA |
| 0 | C100, C107 | NA | Cap-1206-1n/100 V/0.1/X7R | AVX | 12061C102KAT2A |
| 0 | FB_GD | TP SMD | Test pad not assembled | | |
| 0 | J55, J56 | NA | 0R/50 V | Bourns | CR0603-J/-000ELF |
| 0 | Q102, Q103 | NA | OptiMOS transistor 60 V, 3 Ω, 300 mA, SOT23 | Infineon Technologies | 2N7002 |
| 0 | R10, R11 | NA | 510 K/350 V/5 percent | Welwyn Components Limited | MFP1-510KJI |
| 0 | R100, R106 | NA | 47 R/200 V/1 percent | Yageo/Phycomp | RC1206FR-0747RL |
| 0 | R107, R108 | NA | 100 k/150 V/1 percent | Yageo/Phycomp | RC0805FR-07100KL |
| 0 | X21 | NA | Through-hole | Samtec | TSW-102-07-L-S |

BOM

| Quantity | Designator | Value | Description | Manufacturer | Part number |
|----------|------------|-------|---|--------------|-------------|
| | | | 0.025" SQ post header, 2.54 mm pitch, two pin, vertical, single row | | |
| 0 | ZD103 | NA | Zener diode/24 V/SOD-323 | NXP | BZX384-C12 |

7.1 Transformer specifications

This section provides the transformer design data. The necessary steps to design a transformer based on the design specification can be found in the XDPL8220 design guide [\[2\]](#).

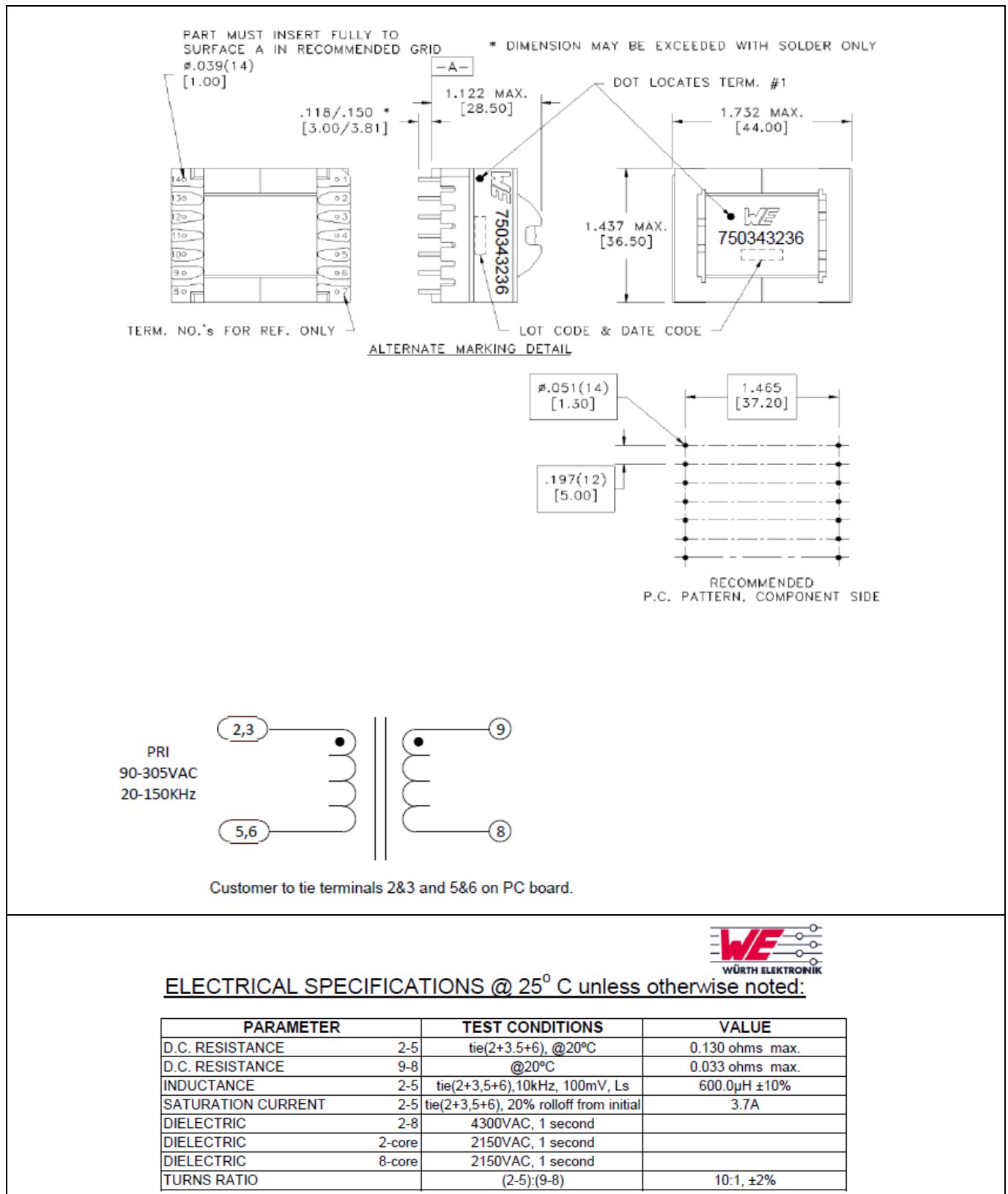


Figure 16 Würth Elektronik PFC choke 750343236 rev00 specification

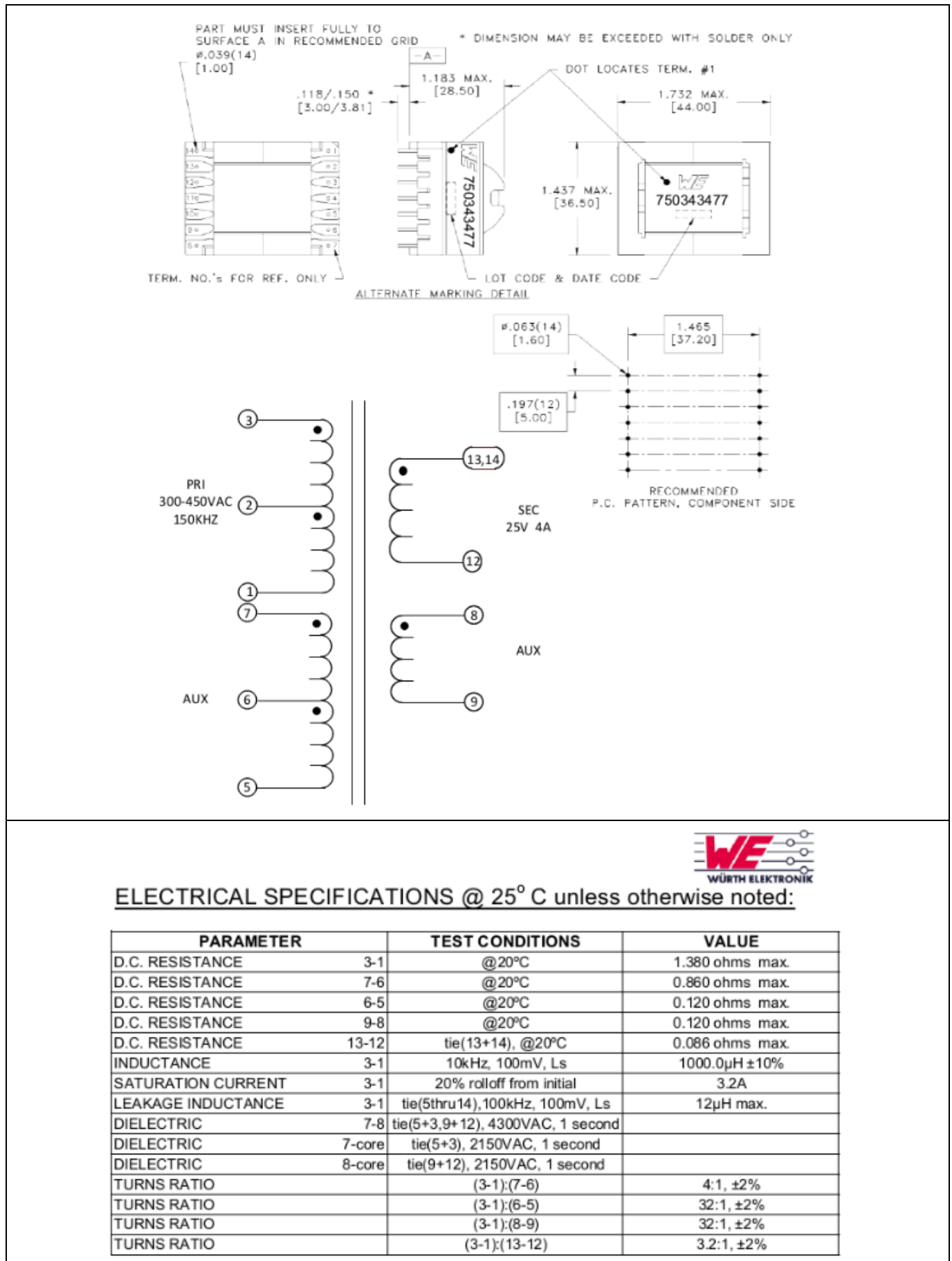


Figure 17 Würth Elektronik Flyback transformer 750343477 rev00 specification

8 Configuration set-up and procedures

8.1 XDPL8220 configuration

The tools needed for XDPL8220 parameter configuration are listed in [Table 9](#).

Table 9 Tools needed for XDPL8220 parameter configuration

| Tool type | Tool name | Description | Ordering/ download link | Ordering/download content |
|-----------|-------------------------------|--|--|--|
| Hardware | .dp Interface Gen2 | Interface to control XDPL8220 from PC | IF-BOARD.DP-GEN2 | .dp Interface Gen2 x 1 USB cable x 1 |
| Software | .dp Vision | Graphical User Interface (GUI) for parameter configuration | .dp Vision | .dp Vision installer (*.exe) |
| | XDPL8220 Parameter *.csv file | XDPL8220 parameter configuration file | XDPL8220 project addon installer <i>Note: Please download the latest version.</i> | XDPL8220 parameter configuration file (*.csv) XDPL8220 CSV file description XDPL8220 documentation (datasheet, application note, design guide) |

Figure 18 shows the hardware set-up needed between the PC and the program connector of the reference design for XDPL8220 parameter configuration.

Note: Please ensure the reference design board is not supplied with any voltage before connecting the programmable cable to the reference design program connector.

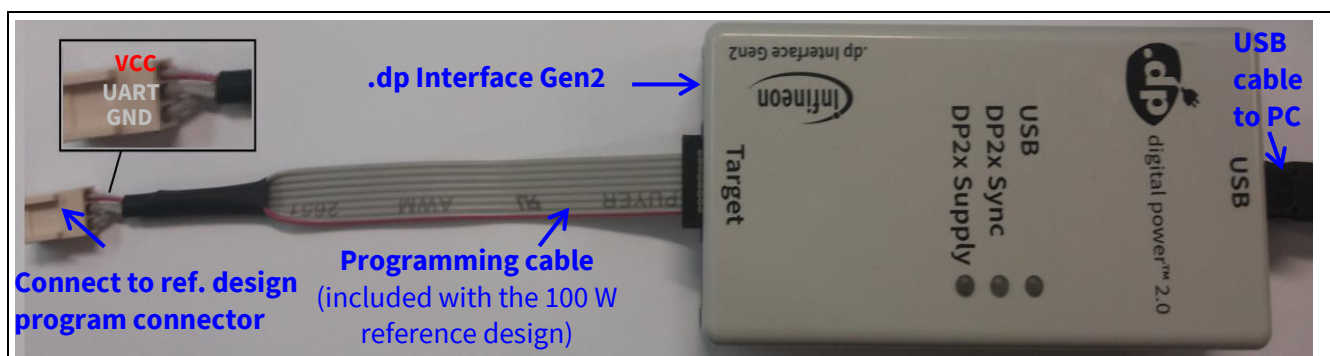


Figure 18 Hardware set-up for XDPL8220 configuration

Configuration set-up and procedures

Please refer to the [.dp Vision user manual](#) for a detailed guide to installation and how to use this GUI for parameter configuration. Alternatively, the following simple guide provides quick and easy reference.

After the tools installation (**Table 9**) and hardware connection for XDPL8220 configuration are done, please start the program by clicking the shortcut “.dp Vision” on the desktop.

Note: During program start-up, if the system shows there is a newer version of .dp Vision, please follow the procedures and update it accordingly.

Next, open the XDPL8220 parameter configuration file (*.csv) in the installation folder of the XDPL8220 project add-on. The default installation folder is at: C:\Users\Username\Infineon Technologies AG\.dp vision basic mode\

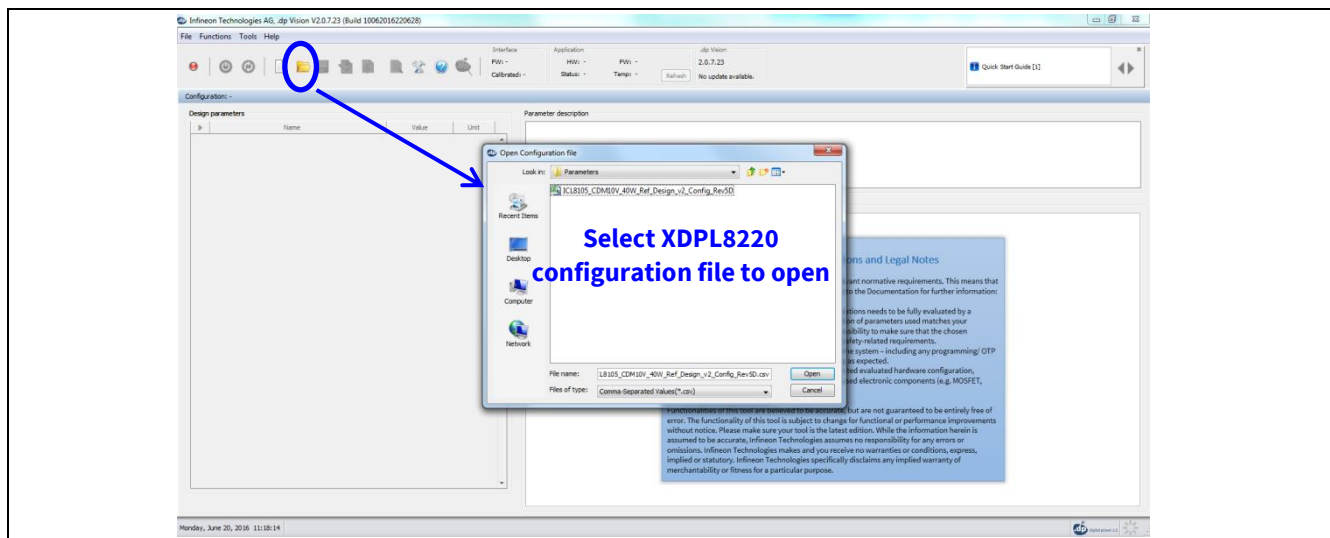


Figure 19 Opening XDPL8220 parameter configuration file (*.csv) in .dp Vision

After opening the parameter *.csv file, a list of XDPL8220 configurable parameters will then be shown (see the box on the left in **Figure 20**). If a parameter value is changed and there is no error detected, the changed value itself will turn blue, like the example of changing *I_{out_full}* parameter from 1500 mA to 1000 mA in **Figure 20**. Otherwise, if there is an error detected (e.g. exceeded min./max. value), the parameter value which caused the error will turn red and the message bar of .dp Vision (see the top right in **Figure 20**) will have an error message.

Note: The user is not allowed to save, test or burn the configuration if there is an error detected.

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XDP™ Digital Power

Configuration set-up and procedures

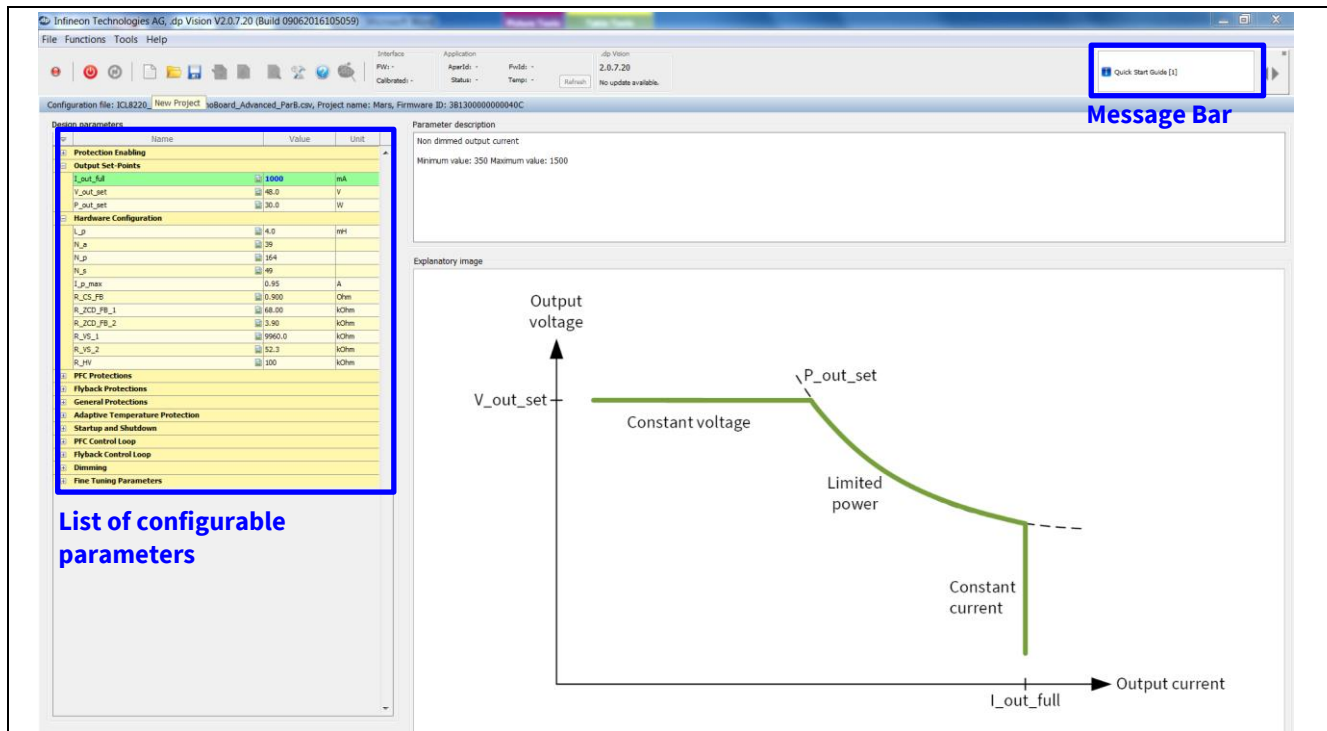


Figure 20 Changing parameter values of XDPL8220 configuration file in .dp Vision

There are two options available to configure the IC based on the parameter values in .dp Vision.

- Burn configuration

As the XDPL8220 chip on the 100 W reference design PCB was already permanently burned with a first full set of parameters in its One-Time Programmable (OTP) memory space, any parameter value change using this option is considered as parameter patching. The OTP memory space dedicated to patching or burning the parameter value change has a memory size of 274 words.





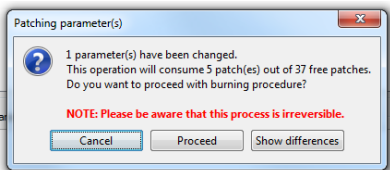
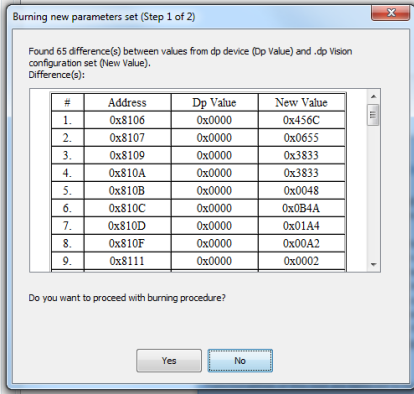
Each time the burn configuration function is executed, it will detect if there is parameter value difference between the saved configuration file and the target XDPL8220. If there is difference detected, each burn configuration will consume a minimum of three words depending on how many parameters need to be patched. However, the process will be aborted if it consumes more memory space than what remains in the target IC. As a result, the user will have to replace the target IC with a new XDPL8220 chip, in order to burn the configuration.

Table 10 shows the recommended procedure for using the burn configuration function in .dp Vision to burn a first full set of new parameters or patch the parameter into the OTP memory.

Table 10 Burn configuration procedure

| Step | Instruction |
|------|--|
| I | Open configuration file (see example in Figure 19). |
| II | If necessary, change any parameter value then press [File] >> [Save] or [File] >> [Save as], to save the configuration file. Otherwise, proceed to step III. |

Configuration set-up and procedures

| | |
|-----|---|
| III | Ensure that the primary supply voltage (e.g. AC input) to the board is switched off or disconnected and the hardware connection for configuration is OK based on Figure 18 . |
| IV | Press  to supply power and establish connection to the target XDPL8220. After this step, XDPL8220 will be in configuration mode and the device status  should change to  . |
| V | <p>Press  to burn configuration into target XDPL8220.</p> <p>After this step, you should see a pop-up window, similar to one of these below.</p> <div style="display: flex; align-items: center; justify-content: center;"> <div style="text-align: center;">  </div> <div style="margin: 0 20px;">OR</div> <div style="text-align: center;">  </div> </div> |
| VI | <p>Press “Proceed” or “Yes” to burn the configuration.</p> <p>After this step, a pop-up window shows the burning was successful.</p> |
| VII | Press “OK” on the pop-up window then disconnect the programming cable from the board connector program and test the application, if needed. |

- Test configuration





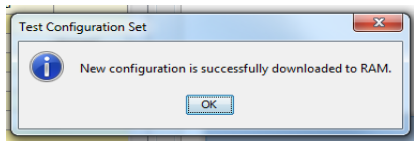
This function will download the parameter values from the list in .dp Vision into the XDPL8220 RAM memory space and it will then be followed by an automatic IC start-up for application testing with the new configuration.

Unlike using the burn configuration, parameter configuration with this option is not permanent because the loaded RAM content will be lost once the IC supply voltage is turned off, but the advantage of using this option is it does not consume OTP memory space, thus there is no limit to the number of parameter value changes.

Table 11 shows the recommended procedure for using the test configuration function in .dp Vision to load the new parameter values into the RAM and test the application with the new configuration.

Table 11 Test configuration procedures

Configuration set-up and procedures

| Step | Instruction |
|------|---|
| I | Open configuration file and change parameter value (see example in Figure 19 and Figure 20). |
| II | Ensure that the primary supply voltage (e.g. AC input) to the board is switched off and the hardware connection for configuration is OK based on Figure 18 . |
| III | Press  to supply power and establish connection to the target XDPL8220. After this step, XDPL8220 will be in configuration mode and the device status  should change to  . |
| IV | Ensure LED output is connected to the board and switch on AC input (e.g. 230 V AC). After this step, the board does not start up because XDPL8220 is still in configuration mode. |
| V | Press  to test configuration with target XDPL8220. After this step, the IC will automatically start up with the new configuration and you should see a pop-up window like the one below:  |
| VI | Press "OK" on the pop-up window. |
| VII | Repeat the steps to test another configuration change. Otherwise, turn off the AC input and disconnect the programming cable from the board connector program. |

Note: If there is any error encountered between steps I and VII, please refer to the message bar of .dp Vision for the error message. For more details, refer to the .dp Vision user manual.

9 References

- [1] XDPL8220 datasheet
- [2] XDPL8220 design guide
- [3] .dp vision – basic mode user manual
- [4] XDPL8220 CSV file description
- [5] Power management selection guide:
<http://www.infineon.com/powermanagement-selectionguide>

References

Revision history

Major changes since the last revision

| Page or reference | Description of change |
|-------------------|-------------------------------|
| All | First release V1.0 2019-07-01 |
| | |

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